VISCOM vision technology

VISCOM

S3088 *flex*

OnDemandHR function provides high-speed inspection of fine-pitch components

> Extended Lifted Lead Detection

Fast program creation with either EasyPro or vVision

Full color evaluation

Integrated Verification ensures a zero defect escape rate





AOI

Efficient electronic assembly inspection Convenient operation High performance and economical

The S3088 *flex* AOI system was developed for reliable, economical defect detection and fast process optimization. From prototypes to large volume, this flexible platform with scalable modular camera technology can handle any inspection task. With the OnDemandHR function, the resolution can be switched between 23.5 and 11.75 μ m/pixel. Furthermore, the high resolution of 16.2 and 8.1 μ m/pixel in angular view also guarantees positive recognition of critical defects, such as fine pitch lifted leads. This standard resolution/high resolution capability detects even the smallest defects on 01005 components.

A key feature of the Viscom AOI is the Integrated Defect Verification. This feature ensures defect detection while reducing false alarms. This gives the system operator a convenient tool to support a zero-escape strategy. The operator is also able to integrate the recommendations of the IPC-A-610E guidelines into the inspection. High performance add-on modules such as verification, offline programming and SPC statistical process evaluation help to provide superior performance.



Technical Specifications

S3088 flex

Application		
Application		Placement and solder joint inspection (reflow and wave soldering)
		Tacement and solder joint inspection (renow and wave soldering)
Camera technology		
Orthogonal camera module 8M (white LEDs)		
	Field of view	57.6 x 43.5 mm
	Resolution	23.5 μ m (standard), 11.75 μ m (high) switchable with OnDemandHR
	Number of mega pixel cameras	4
Angular view camera module 8M (white LEDs)		
	Resolution	16.2 μm (standard), 8.1 μm (high) switchable with OnDemandHR
	Number of mega pixel cameras	4, 8 (option)
Software		
Software		
	User interface SPC	Viscom EasyPro/vVision Viscom SPC (statistical process control), open interface (option)
	Verification station	Viscom S6002 HARAN/vVerify
	Remote diagnosis	Viscom SRC (software remote control) (option)
	Programming station	Viscom PST34 (option)
System computer		
oystelli oomputei	On creating a createry	Windows®
	Operating system Processor	Intel [®] Core™ i7
PCB handling		
	PCB dimensions	508 x 508 mm (20" x 20") (L x W)
	PCB support	
	Transport height Width adjustment	850 to 950 mm ± 20 mm (33.5" x 37.4") Automatic with set-up
	Handling unit	Synchronous linear motor
	Transport concept	Single track transport
	PCB clamping	
	Upper transport clearance Lower transport clearance	35 mm (1.4") (50 mm (2") optional) 40 mm (1.6") (60 mm (2.4") optional)
Inspection speed		
		20 – 40 cm²/s
Other sustain data		
Other system data		
	Interfaces Power requirements	SMEMA, SV70 400 V, 50/60 Hz, 3P/N/PE, consumption 2.5 kVA/h
	System dimensions	1000 x 1540 x 1600 mm (39.4" x 60.6" x 63") (W x D x H)
	Weight	Max. 750 kg (1653 lbs)
Dimensions in mm	997_{-10}^{+10} Ine integration dimensions	Topview with open doors

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